



P-Channel 60 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^d	Q _g (Typ)			
- 60	0.060 at V _{GS} = - 10 V	- 19	26			
	0.077 at V _{GS} = - 4.5 V	- 16.8	20			

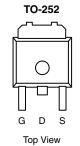
FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

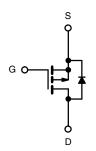


APPLICATIONS

- · High Side Switch for Full Bridge Converter
- · DC/DC Converter for LCD Display



Drain Connected to Tab



P-Channel MOSFET

Ordering Information:	SUD	19P0	6-60-	E3 ((Lead	(P	b)-	-fre	e)

SUD19P06-60-GE3 (Lead (Pb)-free and Halogen free)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise note)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	- 60	V			
Gate-Source Voltage			± 20	V		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	1	- 18.3	^		
Continuous Diam Current (1) = 150 C)	T _C = 125 °C	l _D	- 8.19			
Pulsed Drain Current	I _{DM}	- 30	- A			
Avalanche Current, Single Pulse L = 0.1 mH		I _{AS}			- 22	
Repetitive Avalanche Energy, Single Pulse ^a		E _{AS}	24.2	mJ		
Power Dissipation	T _C = 25 °C	P _D	38.5 ^c	W		
rowei dissipation	T _A = 25 °C	'D	2.3 ^{b, c}	VV		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Marian III II An Ambiant	t ≤ 10 s	R_{thJA}	17	21	°C/W		
Maximum Junction-to-Ambient ^b	Steady State		45	55			
Maximum Junction-to-Case		R_{thJC}	2.7	3.25			

Notes:

- a. Duty cycle \leq 1 %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. See SOA curve for voltage derating.
- d. Based up on $T_C = 25$ °C.

Document Number: 69253 S11-2132 Rev. B, 31-Oct-11



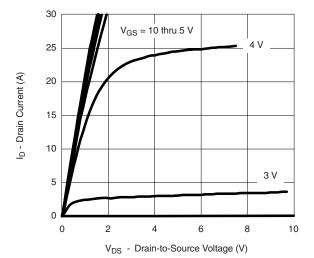
Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = - 60 V, V _{GS} = 0 V			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			- 50	μΑ	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ} \text{ C}$			- 125		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 30			Α	
		V _{GS} = - 10 V, I _D = - 10 A		0.048	0.060	- Ω	
Dunin Course On State Besistance	B	V _{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C			0.102		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C			0.120		
		$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$		0.061	0.077		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10 A		22		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1140	1710	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$		130			
Reverse Transfer Capacitance	C _{rss}			90			
Total Gate Charge ^c	Qg			26	40		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10 \text{ A}$		4.5		nC	
Gate-Drain Charge ^c	Q _{gd}			7		1	
Gate Resistance	Rg	f = 1 MHz		7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	15		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V, R}_{L} = 3 \Omega$		9	15		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -19 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 2.5 \Omega$		65	100	ns	
Fall Time ^c	t _f	1		30	45		
Drain-Source Body Diode and Charact	eristics (T _C = 2	5 °C) ^b					
Continuous Current	I _S				- 30		
Pulsed Current	I _{SM}				- 30	Α	
Forward Voltage ^a	V _{SD}	I _F = - 19 A, V _{GS} = 0 V		- 1	- 1.5	V	
Reverse Recovery Time	t _{rr}	I _F = - 19 A, di/dt = 100 A/μs		41	61	ns	

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

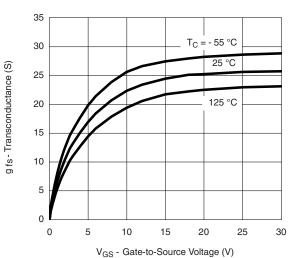
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



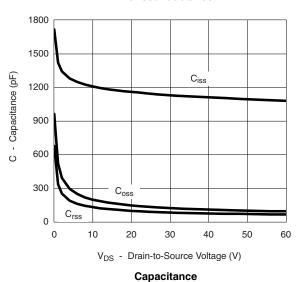
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

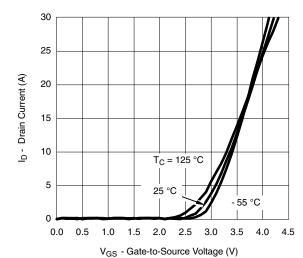


Output Characteristics

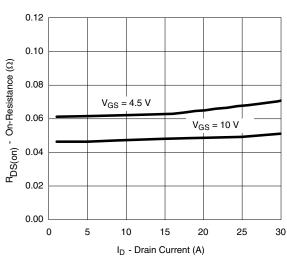


Transconductance

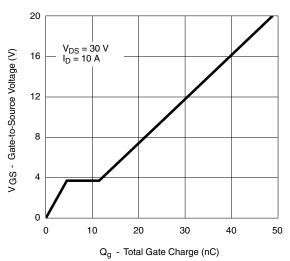




Transfer Characteristics

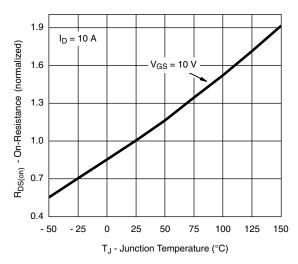


On-Resistance vs. Drain Current

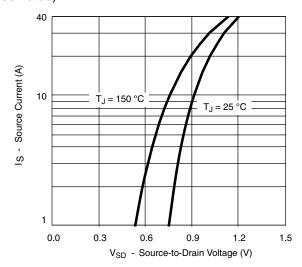


Gate Charge

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

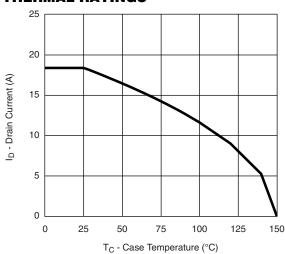


On-Resistance vs. Junction Temperature

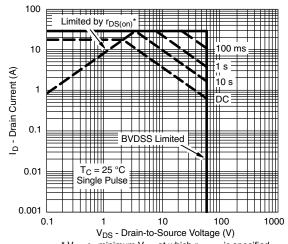


Source-Drain Diode Forward Voltage

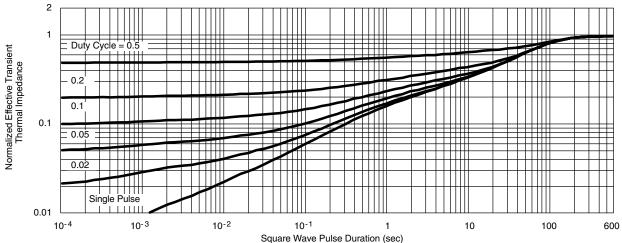
THERMAL RATINGS



Maximum Drain Current vs. Case Temperature



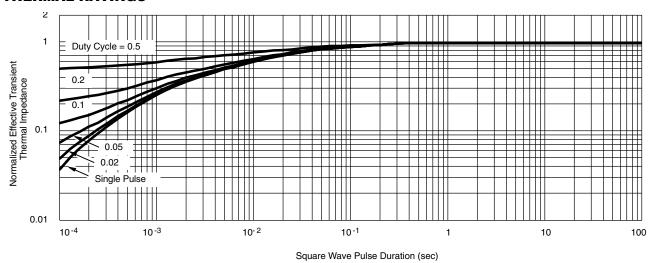
 * V_{GS} > minimum V_{GS} at which $r_{DS(on)}$ is specified Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS

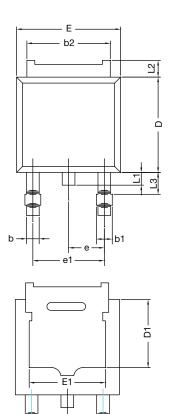


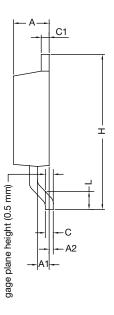
Normalized Thermal Transient Impedance, Junction-to-Case

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TO-252AA CASE OUTLINE





	MILLIMETERS		INC	HES		
DIM.	MIN.	MAX.	MIN.	MAX.		
Α	2.21	2.38	0.087	0.094		
A1	0.89	1.14	0.035	0.045		
A2	0.030	0.127	0.001	0.005		
b	0.71	0.88	0.028	0.035		
b1	0.76	1.14	0.030	0.045		
b2	5.23	5.44	0.206	0.214		
С	0.46	0.58	0.018	0.023		
C1	0.46	0.58	0.018	0.023		
D	5.97	6.22	0.235	0.245		
D1	4.10	4.45	0.161	0.175		
Е	6.48	6.73	0.255	0.265		
E1	4.49	5.50	0.177	0.217		
е	2.28	BSC	0.090 BSC			
e1	4.57	4.57 BSC		BSC		
Η	9.65	10.41	0.380	0.410		
L	1.40	1.78	0.055	0.070		
L1	0.64	1.02	0.025	0.040		
L2	0.89	1.27	0.035	0.050		
L3	1.15	1.52	0.040	0.060		
ECN: T11-0110-Rev. L, 18-Apr-11 DWG: 5347						

Note

• Dimension L3 is for reference only.

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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